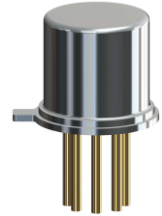
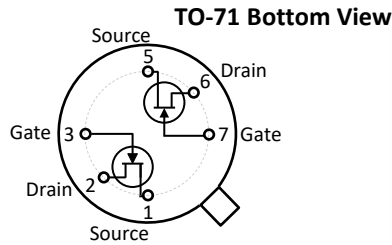


# IFN5197, IFN5198, IFN5199 Dual Matched N-Channel JFET

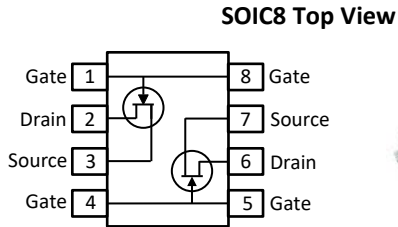
## Features

- InterFET [N0016H Geometry](#)
- Low Leakage: 10 pA Typical
- Low Input Capacitance: 3.5 pF Typical
- High Input Impedance
- Replacement for IFN5197,8,9
- RoHS Compliant
- SMT, TH, and Bare Die Package options.



## Applications

- Low Noise Differential Amplifier
- Differential Amplifier
- JFET Input Op-Amps



## Description

The -50V InterFET IFN5197, IFN5198, and IFN5199 JFET's are targeted for low noise differential amplifier designs. Gate leakages are less than 10pA at room temperatures. The TO-71 package is hermetically sealed and suitable for military applications. Custom specifications, matching, and packaging options are available.

## Product Summary

Parameters	IFN5197 Min	IFN5198 Min	IFN5199 Min	Unit
BV <sub>GSS</sub> Gate to Source Breakdown Voltage	-50	-50	-50	V
I <sub>DSS</sub> Drain to Source Saturation Current	0.7	0.7	0.7	mA
V <sub>GS(off)</sub> Gate to Source Cutoff Voltage	-0.7	-0.7	-0.7	V
G <sub>FS</sub> Forward Transconductance	0.7	0.7	0.7	mS

## Ordering Information Custom Part and Binning Options Available

Part Number	Description	Case	Packaging
IFN5197; IFN5198; IFN5199	Through-Hole	TO-71	Bulk
SMP5197; SMP5198; SMP5199	Surface Mount	SOIC8	Bulk
SMP5197; SMP5198; SMP5199	7" Tape and Reel: Max 500 Pieces 13" Tape and Reel: Max 2,500 Pieces	SOIC8	Minimum 500 Pieces Tape and Reel
IFN5197COT; IFN5198COT; IFN5199COT *	Chip Orientated Tray (COT Waffle Pack)	COT	70/Waffle Pack
IFN5197CFT; IFN5198CFT; IFN5199CFT *	Chip Face-up Tray (CFT Waffle Pack)	CFT	70/Waffle Pack

\* Bare die packaged options are designed for matched specifications but not 100% tested



**Disclaimer:** It is the Buyers responsibility for designing, validating and testing the end application under all field use cases and extreme use conditions. Guaranteeing the application meets required standards, regulatory compliance, and all safety and security requirements is the responsibility of the Buyer. These resources are subject to change without notice.

## Electrical Characteristics

### Maximum Ratings (@ $T_A = 25^\circ\text{C}$ , Unless otherwise specified)

Parameters	Value	Unit
$V_{RGS}$ Reverse Gate Source and Gate Drain Voltage	-50	V
$I_{FG}$ Continuous Forward Gate Current	50	mA
$P_D$ Continuous Device Power Dissipation	250	mW
$P$ Power Derating	4.3	mW/ $^\circ\text{C}$
$T_J$ Operating Junction Temperature	-55 to 125	$^\circ\text{C}$
$T_{STG}$ Storage Temperature	-65 to 150	$^\circ\text{C}$

### Static Characteristics (@ $T_A = 25^\circ\text{C}$ , Unless otherwise specified)

Parameters	Conditions	IFN5197, IFN5198, IFN5199			Unit
		Min	Typ	Max	
$V_{(BR)GSS}$ Gate to Source Breakdown Voltage	$I_G = -1\mu\text{A}, V_{DS} = 0\text{V}$	-50			V
$I_{GSS}$ Gate to Source Reverse Current	$V_{GS} = -30\text{V}, V_{DS} = 0\text{V}, T_A = 25^\circ\text{C}$			-25	pA
	$V_{GS} = -30\text{V}, V_{DS} = 0\text{V}, T_A = 150^\circ\text{C}$			-50	nA
$I_G$ Gate Operating Current	$V_{DS} = 20\text{V}, I_D = 200\mu\text{A}, T_A = 25^\circ\text{C}$			-15	pA
	$V_{DS} = 20\text{V}, I_D = 200\mu\text{A}, T_A = 125^\circ\text{C}$			-15	nA
$V_{GS(OFF)}$ Gate to Source Cutoff Voltage	$V_{DS} = 20\text{V}, I_D = 1\text{nA}$	-0.7		-4.0	V
$V_{GS}$ Gate Source Voltage	$V_{DS} = 20\text{V}, I_D = 200\mu\text{A}$	-0.2		-3.8	V
$I_{DSS}$ Drain to Source Saturation Current	$V_{DS} = 20\text{V}, V_{GS} = 0\text{V}$ (Pulsed)	0.7		7	mA

### Dynamic Characteristics (@ $T_A = 25^\circ\text{C}$ , Unless otherwise specified)

Parameters	Conditions	IFN5197, IFN5198, IFN5199			Unit
		Min	Typ	Max	
$G_{FS}$ Forward Transconductance	$V_{DS} = 20\text{V}, V_{GS} = 0\text{V}, f = 1\text{kHz}$	1		4	mS
	$V_{DS} = 20\text{V}, I_D = 200\mu\text{A}, f = 1\text{kHz}$	0.7		1.6	
$G_{OS}$ Output Conductance	$V_{DS} = 20\text{V}, V_{GS} = 0\text{V}, f = 1\text{kHz}$			50	$\mu\text{S}$
	$V_{DS} = 20\text{V}, I_D = 200\mu\text{A}, f = 1\text{kHz}$			4	
$C_{ISS}$ Input Capacitance	$V_{DS} = 20\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$			6	pF
$C_{RSS}$ Reverse Capacitance	$V_{DS} = 20\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$			2	pF
$e_n$ Equivalent Circuit Input Noise Voltage	$V_{DS} = 20\text{V}, I_D = 200\mu\text{A}, f = 1\text{kHz}$			20	nV/ $\sqrt{\text{Hz}}$
$ V_{GS1} - V_{GS2} $ Differential Gate Source Voltage	$V_{DS} = 20\text{V}, I_D = -200\mu\text{A}$	IFN5197		5	mV
		IFN5198		10	
		IFN5199		15	
$\frac{ V_{GS1} - V_{GS2} }{\Delta T}$ Differential Gate Source Voltage with Temperature	$V_{DS} = 20\text{V}, I_D = 200\mu\text{A}$ $T_A = 25^\circ\text{C}, T_B = 125^\circ\text{C}$	IFN5197		1	$\text{mV}/^\circ\text{C}$
		IFN5198		2.5	
		IFN5199		4	

